



DUAL SCHMITT TRIGGER BUFFERS

Description

The DIODES™ 74LVC2G17 is a dual Schmitt trigger buffer gate with standard push-pull outputs. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

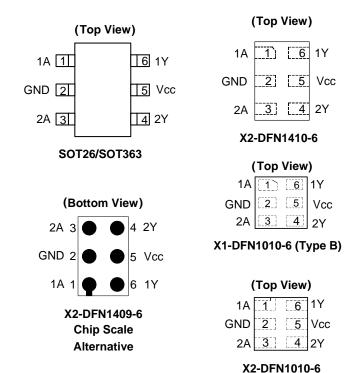
The gate performs the positive Boolean function:

Y = A

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ±24mA Output Drive at 3.0V
- CMOS Low Power Consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs Accept up to 5.5V
- ESD Protection Tested per JESD 22
- Exceeds 2000V Human Body Model (A114)
- Exceeds 1000V Charged Device Model (C101)
- Latch-up Exceeds 100mA per JESD 78, Class I
- X2-DFN1409-6 Package Designed as a Direct Replacement for Chip Scale Packaging
- Range of Package Options SOT26, SOT363, X1-DFN1010-6 (Type B), X2-DFN1010-6, X2-DFN1409-6, and X2-DFN1410-6
- Leadless Packages Named per JESD30E
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Pin Assignments



Applications

- Voltage level shifting
- General purpose logics
- Power down signal isolations
- Wide array of products such as:
 - PCs, networking, notebooks, netbooks, tablets
 - Computer peripherals, hard drives, SSD, CD/DVD ROM
 - TV, DVD, DVR, set-top boxes
 - Cell phones, personal navigations/GPS
 - MP3 players, cameras, video recorders

Notes:

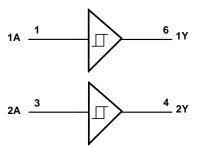
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Name	Pin Number	Function		
1A	1	Data Input		
GND	2	Ground		
2A	3	Data Input		
2Y	4	Data Output		
Vcc	5	Supply Voltage		
1Y	6	Data Output		

Logic Diagram



Function Table

Inputs	Output
Α	Y
Н	Н
L	L

Absolute Maximum Ratings (Notes 4 & 5) (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
Vcc	Supply Voltage Range	-0.5 to +6.5	V
Vı	Input Voltage Range	-0.5 to +6.5	V
Vo	Voltage Applied to Output in High Impedance or IOFF State	-0.5 to +6.5	V
Vo	Voltage Applied to Output in High or Low State	-0.3 to Vcc +0.5	V
I _{IK}	Input Clamp Current V _I < 0	-50	mA
Іок	Output Clamp Current Vo < 0	-50	mA
lo	Continuous Output Current	-50	mA
_	Continuous Current Through V _{DD} or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
Tstg	Storage Temperature	-65 to +150	°C

Note:

- Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.
 Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum woltage. The ratings of both current and voltage must be maintained within the controlled range.



Recommended Operating Conditions (Note 6) (@TA = +25°C, unless otherwise specified.)

Symbol		Parameter	Min	Max	Unit	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	On a ratio a Malta a a	Operating	1.65	5.5	V	
Vcc	Operating Voltage	Data Retention Only	1.5	_	V	
Vı	Input Voltage		0	5.5	V	
Vo	Output Voltage		0	Vcc	V	
		Vcc = 1.65V	_	-4		
		V _{CC} = 2.3V	_	-8		
Іон	High-Level Output Current	V 0V	_	-16	mA	
		Vcc = 3V	_	-24		
		V _{CC} = 4.5V	_	-32		
		Vcc = 1.65V	_	4		
		Vcc = 2.3V	_	8		
loL	Low-Level Output Current	V 2V	_	16	mA	
		$V_{CC} = 3V$	_	24		
		Vcc = 4.5V	_	32		
		Vcc = 1.8V ± 0.15V, 2.5V ± 0.2V	_	20	ns/V	
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 3.3V \pm 0.3V$	_	10		
		$V_{CC} = 5V \pm 0.5V$	_	5		
TA	Operating Free-Air Temperature	_	-40	+125	°C	

Note: 6. Unused inputs should be held at V_{CC} or Ground.



Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Cumbal	Parameter	Test Conditions	v	-40°C to	+85°C	-40°C to	+125°C	Unit
Symbol	Parameter	rest Conditions	V _{CC}	Min	Max	Min	Max	Unit
			1.8V	0.70	1.50	0.70	1.70	
			2.3V	1.00	1.80	1.00	2.00	
V _{T+}	Positive-Going Input Threshold Voltage	_	3V	1.30	2.20	1.30	2.40	V
	Threshold voltage		4.5V	1.90	3.10	1.90	3.30	
			5.5V	2.20	3.60	2.20	3.80	
			1.8V	0.25	0.90	0.25	1.10	
			2.3V	0.40	1.15	0.4	1.35	
V_{T-}	Negative-Going Input Threshold Voltage	_	3V	0.60	1.50	0.6	1.7	V
	Threshold Voltage		4.5V	1.00	2.00	1	2.2	
			5.5V	1.20	2.30	1.2	2.5	
			1.8V	0.15	1.00	0.15	1.2	
	ΔVτ Hysteresis (V _{T+} - V _{T-)}		2.3V	0.25	1.10	0.25	1.3	
ΔVT		_	3V	0.40	1.20	0.40	1.40	V
			4.5V	0.60	1.50	0.60	1.70	
			5.5V	0.70	1.70	0.70	1.90	
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} - 0.1	_	V _{CC} - 0.1	_	
		$I_{OH} = -4mA$	1.65V	1.2	ı	0.95		
Mari	High-Level Output Voltage	Iон = -8mA	2.3V	1.9	ı	1.7		V
Vон	High-Level Output voltage	$I_{OH} = -16mA$	3V	2.4	1	2.2	1	V
		I _{OH} = -24mA	3v	2.3		2.0		
		I _{OH} = -32mA	4.5V	3.8	ı	3.4		
		$I_{OL} = 100 \mu A$	1.65V to 5.5V	_	0.1	_	0.10	
		$I_{OL} = 4mA$	1.65V	_	0.45	_	0.70	
Vol	Low-Level Output Voltage	$I_{OL} = 8mA$	2.3V	_	0.3	_	0.45	V
VOL	Low-Level Output Voltage	IoL = 16mA	3V	_	0.4	_	0.60	V
		$I_{OL} = 24mA$	3 v	_	0.55	_	0.80	
		IoL = 32mA	4.5V	_	0.55	_	0.80	
lı	Input Current	V _I = 5.5V or GND	0 to 5.5V	_	± 5	_	± 20	μA
loff	Power Down Leakage Current	V _I or V _O = 5.5V	0	_	± 10	_	± 20	μΑ
Icc	Supply Current	$V_1 = 5.5V$ or GND, $I_0 = 0$	1.65V to 5.5V	_	10	_	40	μA



Package Characteristics ($@T_A = +25^{\circ}C$, $V_{CC} = 3.3V$, unless otherwise specified.)

Symbol	Parameter	Package	Conditions	Min	Тур	Max	Unit
Сі	Input Capacitance	Typical of all packages	$V_{CC} = 3.3V$ $V_{I} = V_{CC}$ or GND	_	3.5	_	pF
		SOT26		_	204	_	
		SOT363		_	371	_	
0	θ _{JA} Thermal Resistance Junction-to- Ambient	X2-DFN1410-6	(Nata 7)	_	430	_	°C/W
ÐJA		X2-DFN1409-6	(Note 7)	_	450	_	
		X1-DFN1010-6 (Type B)		_	495	_	
		X2-DFN1010-6		_	510	_	
		SOT26		_	52	_	
		SOT363		_	143	_	
•	Thermal Resistance Junction-to-	X2-DFN1410-6	(NI=4= 7)	_	190	_	0000
θις	Case	X2-DFN1409-6	(Note 7)		225	_	°C/W
		X1-DFN1010-6 (Type B)	1	_	245	_	
		X2-DFN1010-6	1	_	250	_	

Note:

Switching Characteristics

 $T_A = -40$ °C to +85°C, $C_L = 30$ pF or 50pF (See Figure 1)

Parameter	From	To (Output)		= 1.8V .15V		= 2.5V).2V	V _{CC} = ± 0	: 3.3V :3V	V _{CC} ± 0	= 5V).5V	Unit
	(Input)	(Output)	Min	Max	Min	Max	Min	Max	Min	Max	
tpD	А	Y	0.5	10.5	0.5	6.5	0.5	5.7	0.5	4.3	ns

 $T_A = -40$ °C to +125°C, $C_L = 30$ pF or 50pF (See Figure 1)

14 = 40 0 to +123 0, ot = 30pr (occ rigure r)											
Parameter	From (Input)	To		= 1.8V .15V		: 2.5V).2V		= 3.3V).3V		= 5V).5V	Unit
	(input)	(Output)	Min	Max	Min	Max	Min	Max	Min	Max	
tpD	Α	Y	0.5	13.1	0.5	8.5	0.5	7.1	0.5	5.4	ns

Operating Characteristics

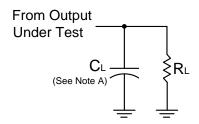
$T_A = +25$ °C

	Parameter	Test	V _{CC} = 1.8V	V _{CC} = 2.5V	$V_{CC} = 3.3V$	V _{CC} = 5V	Unit	
	Farameter	Conditions	Тур	Тур	Тур	Тур	Offic	
CPD	Power Dissipation Capacitance	f = 10MHz	17	19	20	21	pF	

^{7.} Test condition for all packages: Device mounted on FR-4 substrate PC board, 2oz copper with minimum recommended pad layout.



Parameter Measurement Information



Vcc	Inp	outs	VM	C.	RL	
VCC	VI	t _R /t _F	VM	C∟		
1.8V ± 0.15V	Vcc	≤ 2ns	Vcc/2	30pF	1kΩ	
2.5V ± 0.2V	Vcc	≤ 2ns	Vcc/2	30pF	500Ω	
$3.3V \pm 0.3V$	3V	≤ 2.5ns	1.5V	50pF	500Ω	
5V ± 0.5V	Vcc	≤ 2.5ns	Vcc/2	50pF	500Ω	

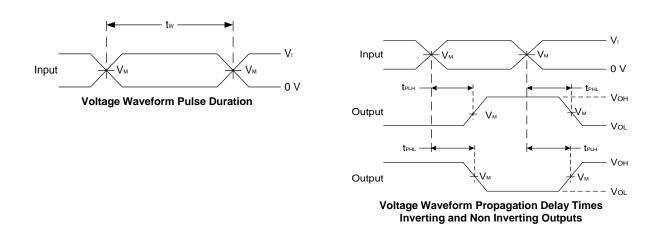


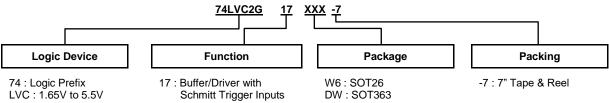
Figure 1 Load Circuit and Voltage Waveforms

Notes:

- A. Includes test lead and test apparatus capacitance.
 B. All pulses are supplied at pulse repetition rate ≤ 10MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{PD} .



Ordering Information



Logic Family 2G: Two Gates

Schmitt Trigger Inputs

DW: SOT363

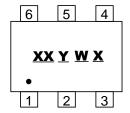
FW5: X1-DFN1010-6 (Type B) FW4: X2-DFN1010-6 FX4: X2-DFN1409-6 FZ4: X2-DFN1410-6

Part Number	Part Number	Package	Package (Note 8)	Package Size	Packing (Note 9)		
Part Number	Suffix	Code	Package (Note o)	Fackage Size	Qty.	Carrier	
74LVC2G17W6-7	-7	W6	SOT26	2.8mm x 2.2mm x 1.1mm 0.95mm Lead Pitch	3000	Tape & Reel	
74LVC2G17DW-7	-7	DW	SOT363	2.0mm x 2.0mm x 1.1mm 0.65mm Lead Pitch	3000	Tape & Reel	
74LVC2G17FW5-7	-7	FW5	X1-DFN1010-6 (Type B)	1.0mm x 1.0mm x 0.5mm 0.35mm Pad Pitch	5000	Tape & Reel	
74LVC2G17FW4-7	-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35mm Pad Pitch	5000	Tape & Reel	
74LVC2G17FX4-7	-7	FX4	X2-DFN1409-6 Chip Scale Alternative	1.4mm x 0.9mm x 0.4mm 0.5mm Pad Pitch	5000	Tape & Reel	
74LVC2G17FZ4-7	-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5mm Pad Pitch	5000	Tape & Reel	

Notes: 8. Pad layout as shown on Diodes Incorporated's website at http://www.diodes.com/package-outlines.html.

Marking Information

(1) SOT26, SOT363



XX: Identification Code

 \underline{Y} : Year 0 to 9 (ex: 2 = 2022)

W: Week: A to Z: Week 1 to 26;

a to z: Week 27 to 52; z Represents

Week 52 and 53 X: A to Z: Internal Code

Part Number	Package	Identification Code		
74LVC2G17W6-7	SOT26	Z6		
74LVC2G17DW-7	SOT363	Z6		

^{9.} The taping orientation is located on our website at https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.



Marking Information (continued)

(2) X1-DFN1010-6 (Type B), X2-DFN1010-6, X2-DFN1409-6, X2-DFN1410-6

(Top View)

 \underline{XX} : Identification Code \underline{Y} : Year 0 to 9 (ex: 2 = 2022)

<u>W</u>: Week: A to Z: Week 1 to 26; a to z: Week 27 to 52; z Represents

Week 52 and 53 X: A to Z: Internal Code

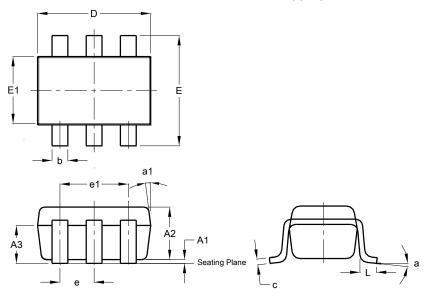
Part Number	Package	Identification Code
74LVC2G17FW4-7	X2-DFN1010-6	Z6
74LVC2G17FW5-7	X1-DFN1010-6 (Type B)	W6
74LVC2G17FX4-7	X2-DFN1409-6	X6
74LVC2G17FZ4-7	X2-DFN1410-6	Z6



Package Outline Dimensions

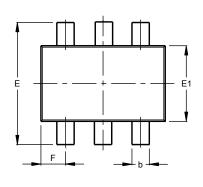
Please see http://www.diodes.com/package-outlines.html for the latest version.

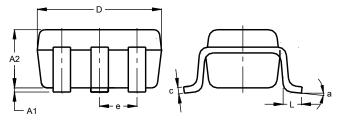
SOT26



SOT26			
Dim	Min	Max	Тур
A1	0.013	0.10	0.05
A2	1.00	1.30	1.10
A3	0.70	0.80	0.75
b	0.35	0.50	0.38
C	0.10	0.20	0.15
D	2.90	3.10	3.00
е	-	-	0.95
e1	-	-	1.90
Е	2.70	3.00	2.80
E1	1.50	1.70	1.60
١	0.35	0.55	0.40
а	-	-	8°
a1	-	-	7°
All Dimensions in mm			

SOT363





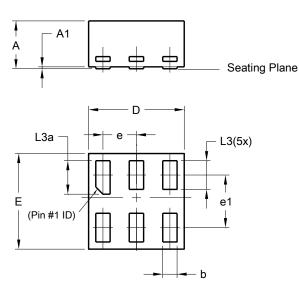
SOT363			
Dim	Min	Max	Тур
A 1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
C	0.10	0.22	0.11
D	1.80	2.20	2.15
Е	2.00	2.20	2.10
E1	1.15	1.35	1.30
е	e 0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
а	0°	8°	
All Dimensions in mm			



Package Outline Dimensions (continued)

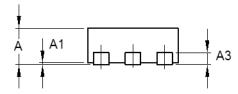
Please see http://www.diodes.com/package-outlines.html for the latest version.

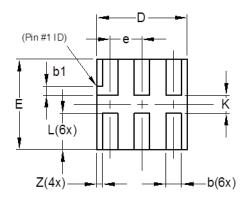
X1-DFN1010-6 (Type B)



	X1-DFN1010-6 (Type B)			
Dim	Min	Max	Тур	
Α	-	0.50	0.39	
A1	-	0.04	-	
b	0.12	0.20	0.15	
D	0.95	1.050	1.00	
Е	0.95	1.050	1.00	
е	0.35 BSC			
e1	0.55 BSC			
L3	0.27	0.30	0.30	
L3a	0.32	0.40	0.35	
All Dimensions in mm				

X2-DFN1010-6





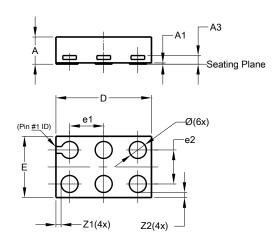
X2-DFN1010-6			
Dim	Min	Max	Тур
Α		0.40	0.39
A1	0.00	0.05	0.02
A3		_	0.13
b	0.14	0.20	0.17
b1	0.05	0.15	0.10
D	0.95	1.05	1.00
E	0.95	1.05	1.00
е	_	_	0.35
L	0.35	0.45	0.40
K	0.15	_	_
Z	_	_	0.065
All Dimensions in mm			



Package Outline Dimensions (continued)

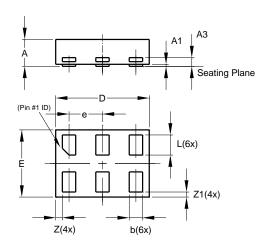
Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1409-6



	X2-DFN1409-6			
Dim	Dim Min Max Typ			
Α	1	0.40	0.39	
A1	0	0.05	0.02	
A3	-	-	0.13	
Ø	0.20	0.30	0.25	
D	1.35	1.45	1.40	
Е	0.85	0.95	0.90	
e1	1	-	0.50	
e2	-	-	0.50	
Z 1	-	-	0.075	
Z2	1	-	0.075	
All [All Dimensions in mm			

X2-DFN1410-6



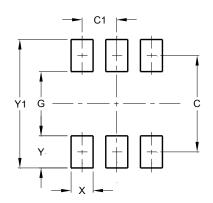
X2-DFN1410-6			
Dim	Min	Max	Тур
Α		0.40	0.39
A1	0.00	0.05	0.02
A3			0.13
b	0.15	0.25	0.20
D	1.35	1.45	1.40
Е	0.95	1.05	1.00
е			0.50
L	0.25	0.35	0.30
Z	_		0.10
Z1	0.045	0.105	0.075
All Dimensions in mm			



Suggested Pad Layout

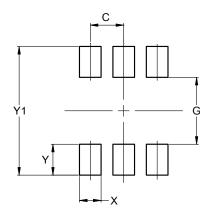
Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT26



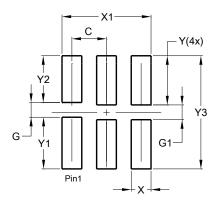
Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Υ	0.80
Y1	3.20

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

X1-DFN1010-6 (Type B)



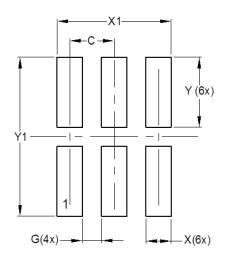
Dimensions	Value (in mm)
	(111 111111)
С	0.350
G	0.150
G1	0.150
Х	0.200
X1	0.900
Υ	0.500
Y1	0.525
Y2	0.475
Y3	1.150



Suggested Pad Layout (continued)

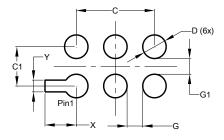
Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1010-6



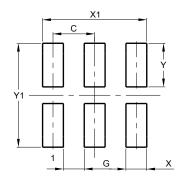
Dimensions	Value (in mm)
С	0.350
G	0.150
Х	0.200
X1	0.900
Y	0.550
Y1	1.250

X2-DFN1409-6



Dimensions	Value (in mm)
С	1.000
C1	0.500
D	0.300
G	0.200
G1	0.200
X	0.400
Υ	0.150

X2-DFN1410-6



Dimensions	Value (in mm)
С	0.500
G	0.250
Х	0.250
X1	1.250
Υ	0.525
Y1	1.250



Mechanical Data

SOT26

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.016 grams (Approximate)

SOT363

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.006 grams (Approximate)

X1-DFN1010-6 (Type B)

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)

X2-DFN1010-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)

X2-DFN1409-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.002 grams (Approximate)

X2-DFN1410-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.002 grams (Approximate)



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